



Vincotech

flow PIM 0 3<sup>rd</sup> gen

1200 V / 4 A

**Features**

- 2 Clips housing in 12 and 17mm height
- Trench Fieldstop Technology IGBT4
- Enhanced Rectifier
- Optional w/o BRC

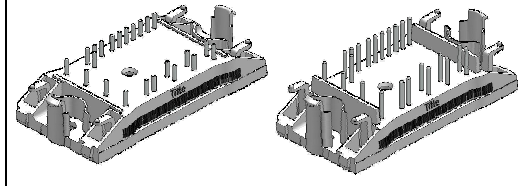
**Target Applications**

- Industrial Drives
- Embedded Generation

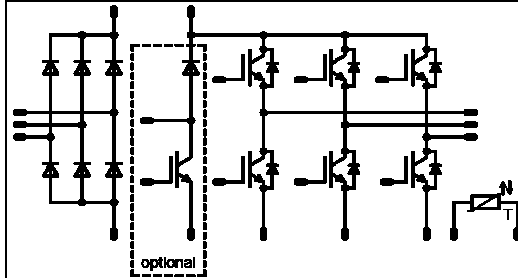
**Types**

- V23990-P848-A58-PM 12mm housing
- V23990-P848-A59-PM 17mm housing
- V23990-P848-C58-PM 12mm housing; w/o BRC
- V23990-P848-C59-PM 17mm housing; w/o BRC

flow PIM 0 3<sup>rd</sup> gen



**Schematic**



Maximum Ratings

$T_j=25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Input Rectifier Diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$		1600	V
DC forward current	$I_{FAV}$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	34 34	A
Surge forward current	$I_{FSM}$	$t_p=10\text{ms}$ $T_j=25^{\circ}\text{C}$	370	A
I2t-value	$I^2t$		370	A <sup>2</sup> s
Power dissipation	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	39 64	W
Maximum Junction Temperature	$T_{jmax}$		150	$^{\circ}\text{C}$
<b>Inverter Transistor</b>				
Collector-emitter break down voltage	$V_{CE}$		1200	V
DC collector current	$I_C$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	9 10	A
Pulsed collector current	$I_{Cpulse}$	$t_p$ limited by $T_{jmax}$	12	A
Turn off safe operating area		$V_{CE} \leq 1200\text{V}$ , $T_j \leq T_{op max}$	8	A
Power dissipation	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	38 57	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^{\circ}\text{C}$ $V_{GE} = 15\text{V}$	10 800	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{jmax}$		175	$^{\circ}\text{C}$



## Maximum Ratings

 $T_j=25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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**Inverter Diode**

Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	10 10	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	32	A
Power dissipation	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	37 56	W
Maximum Junction Temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

**Brake Transistor**

Collector-emitter break down voltage	$V_{CE}$		1200	V
DC collector current	$I_C$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	8 10	A
Pulsed collector current	$I_{Cpulse}$	$t_p$ limited by $T_{jmax}$	12	A
Turn off safe operating area		$V_{CE} \leq 1200\text{V}$ , $T_j \leq T_{op max}$	8	A
Power dissipation	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	32 49	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^{\circ}\text{C}$ $V_{GE} = 15\text{V}$	10 800	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

**Brake Diode**

Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	6 6	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	6	A
Power dissipation	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	18 28	W
Maximum Junction Temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

**Thermal Properties**

Storage temperature	$T_{stg}$		-40...+125	$^{\circ}\text{C}$
Operation temperature under switching condition	$T_{op}$		-40...+( $T_{jmax} - 25$ )	$^{\circ}\text{C}$

**Insulation Properties**

Insulation voltage	$V_{is}$	$t=2\text{s}$ DC voltage	4000	V
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm
Comparative tracking index	CTI		>200	

### Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$	Min	Typ	Max		

#### Input Rectifier Diode

Forward voltage	$V_F$				30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1,19 1,17	1,7		V
Threshold voltage (for power loss calc. only)	$V_{to}$				30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	0,91 0,79			V
Slope resistance (for power loss calc. only)	$r_t$				30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	8 11			m $\Omega$
Reverse current	$I_r$			1500		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		0,1		mA
Thermal resistance chip to heatsink	$R_{thjH}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 1 \text{ W/mK}$						1,80		K/W
Thermal resistance chip to heatsink	$R_{thjH}$	Phase-Change Material $\lambda=3,4\text{W/mK}$						1,54		K/W

#### Inverter Transistor

Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,0008	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		50	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1,95 2,28			V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	600		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$			0,05	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$			200	nA
Integrated Gate resistor	$R_{gint}$							none		$\Omega$
Turn-on delay time	$t_{d(on)}$	Rgoff=64 $\Omega$ Rgon=64 $\Omega$	$\pm 15$	600	4	$T_j=25^\circ\text{C}$		77		ns
Rise time	$t_r$					$T_j=125^\circ\text{C}$		75		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$		18		
Fall time	$t_f$					$T_j=125^\circ\text{C}$		23		
Turn-on energy loss	$E_{on}$					$T_j=25^\circ\text{C}$		176		
Turn-off energy loss	$E_{off}$					$T_j=125^\circ\text{C}$		226		
Input capacitance	$C_{ies}$							250		pF
Output capacitance	$C_{oss}$	f=1MHz	0	25		$T_j=25^\circ\text{C}$		25		
Reverse transfer capacitance	$C_{rss}$							15		
Gate charge	$Q_G$		$\pm 15$	960	4	$T_j=25^\circ\text{C}$		25		nC
Thermal resistance chip to heatsink	$R_{thjH}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 1 \text{ W/mK}$						2,51		K/W
Thermal resistance chip to heatsink	$R_{thjH}$	Phase-Change Material $\lambda=3,4\text{W/mK}$						2,18		K/W

#### Inverter Diode

Diode forward voltage	$V_F$				10	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1,35	1,41 1,25	2,2	V
Peak reverse recovery current	$I_{RRM}$	Rgon=64 $\Omega$	15	600	10	$T_j=25^\circ\text{C}$		5,24		A
Reverse recovery time	$t_{rr}$					$T_j=125^\circ\text{C}$		6,35		
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ\text{C}$		248		
Peak rate of fall of recovery current	$di(\text{rec})_{\text{max}}/dt$					$T_j=125^\circ\text{C}$		431		
Reverse recovered energy	$E_{rec}$					$T_j=25^\circ\text{C}$		0,58		
						$T_j=125^\circ\text{C}$		1,24		
Thermal resistance chip to heatsink	$R_{thjH}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 1 \text{ W/mK}$						2,56		K/W
Thermal resistance chip to heatsink	$R_{thjH}$	Phase-Change Material $\lambda=3,4\text{W/mK}$						2,23		K/W

### Characteristic Values

Parameter	Symbol	Conditions					Value			Unit	
		$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$	Min	Typ	Max			
<b>Brake Transistor</b>											
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,00015	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	5	5,8	6,5	V	
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		4	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		1,96 2,27		V	
Collector-emitter cut-off incl diode	$I_{CES}$		0	1200		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$			0,05	mA	
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$			200	nA	
Integrated Gate resistor	$R_{gint}$							none		$\Omega$	
Turn-on delay time	$t_{d(on)}$	Rgoff=64 $\Omega$ Rgon=64 $\Omega$	$\pm 15$	600	4	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		78 75		ns	
Rise time	$t_r$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		18 24			
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		170 217			
Fall time	$t_f$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		81 103			
Turn-on energy loss	$E_{on}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,24 0,36			mWs
Turn-off energy loss	$E_{off}$	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,22 0,33							
Input capacitance	$C_{ies}$	f=1MHz	0	25		$T_j=25^\circ\text{C}$		250		pF	
Output capacitance	$C_{oss}$							25			
Reverse transfer capacitance	$C_{rss}$							15			
Gate charge	$Q_G$		15	960	4	$T_j=25^\circ\text{C}$		25		nC	
Thermal resistance chip to heatsink	$R_{thjH}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 1 \text{ W/mK}$						2,95		K/W	
Thermal resistance chip to heatsink	$R_{thjH}$	Phase-Change Material $\lambda = 3,4 \text{ W/mK}$						2,56		K/W	
<b>Brake Diode</b>											
Diode forward voltage	$V_F$				4	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1	1,88 1,79	2,35	V	
Reverse leakage current	$I_r$		15	600	4	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$			250	$\mu\text{A}$	
Peak reverse recovery current	$I_{RRM}$	Rgon=64 $\Omega$ Rgon=64 $\Omega$	15	600	4	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		4,03 4,52		A	
Reverse recovery time	$t_{rr}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		276 485			
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,43 0,43			$\mu\text{C}$
Peak rate of fall of recovery current	$\frac{di(\text{rec})_{\text{max}}}{dt}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		37 31			
Reverse recovery energy	$E_{rec}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$					0,17 0,38
Thermal resistance chip to heatsink	$R_{thjH}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 1 \text{ W/mK}$						3,86		K/W	
Thermal resistance chip to heatsink	$R_{thjH}$	Phase-Change Material $\lambda = 3,4 \text{ W/mK}$						3,38		K/W	
<b>Thermistor</b>											
Rated resistance	$R$					$T=25^\circ\text{C}$		22000		$\Omega$	
Deviation of R100	$\Delta R/R$	R100=1486 $\Omega$				$T=100^\circ\text{C}$	-5		5	%	
Power dissipation	$P$					$T=25^\circ\text{C}$		210		mW	
Power dissipation constant						$T=25^\circ\text{C}$		3,5		mW/K	
B-value	B(25/50)	Tol. $\pm 3\%$				$T=25^\circ\text{C}$		3940		K	
B-value	B(25/100)	Tol. $\pm 3\%$				$T=25^\circ\text{C}$		4000		K	
Vincotech NTC Reference									A		

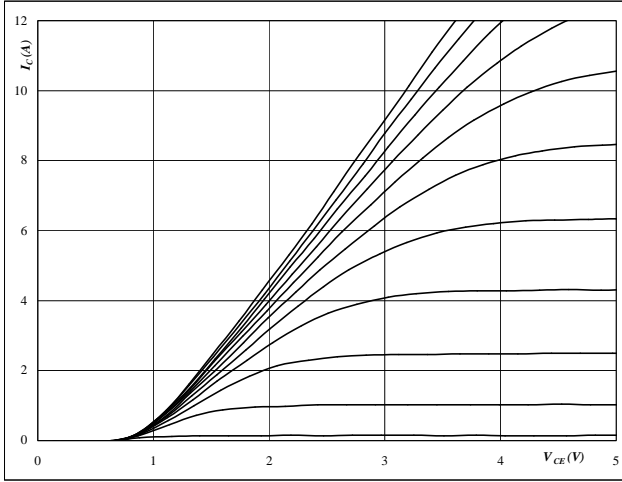


# Output Inverter

Figure 1 Output inverter IGBT

### Typical output characteristics

$I_C = f(V_{CE})$

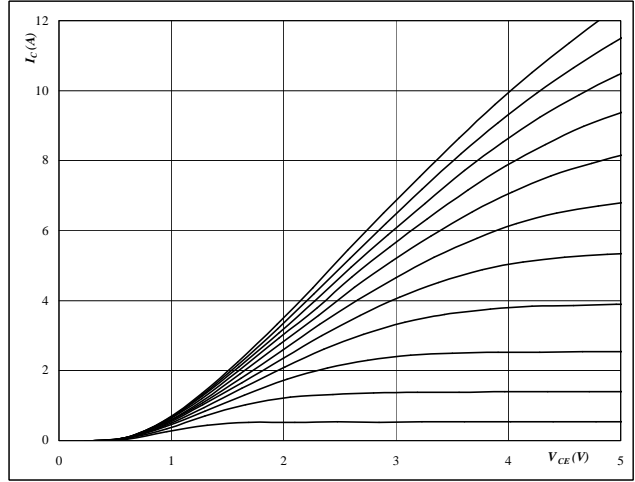


**At**  
 $t_p = 250 \mu s$   
 $T_j = 25 \text{ }^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

Figure 2 Output inverter IGBT

### Typical output characteristics

$I_C = f(V_{CE})$

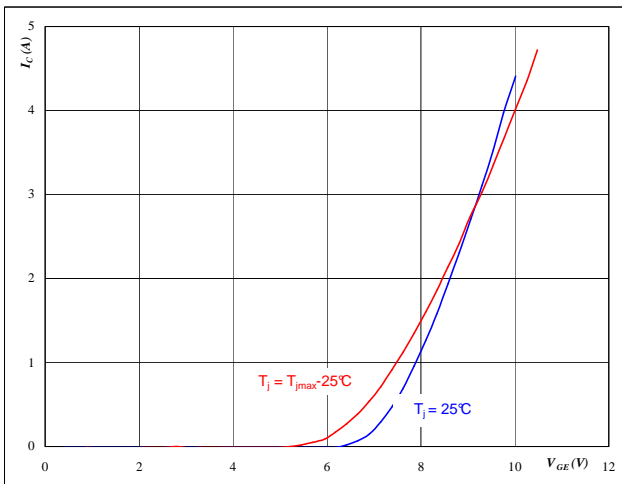


**At**  
 $t_p = 250 \mu s$   
 $T_j = 150 \text{ }^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

Figure 3 Output inverter IGBT

### Typical transfer characteristics

$I_C = f(V_{GE})$

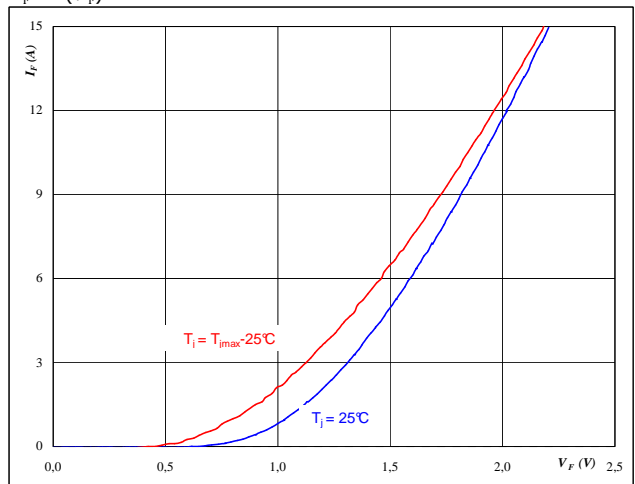


**At**  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 \text{ V}$

Figure 4 Output inverter FWD

### Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



**At**  
 $t_p = 250 \mu s$

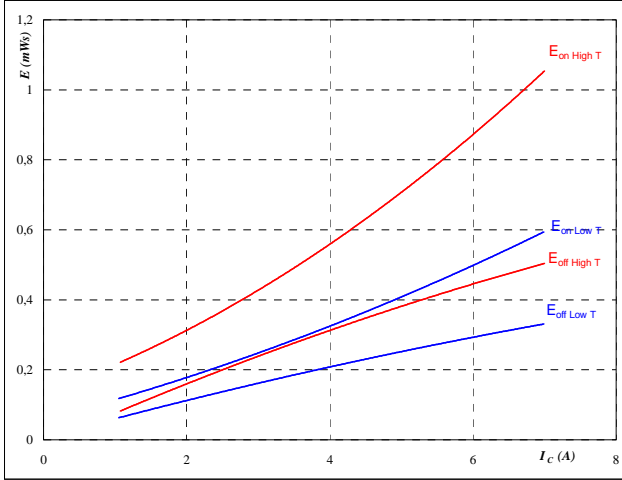


## Output Inverter

**Figure 5** Output inverter IGBT

Typical switching energy losses  
as a function of collector current

$$E = f(I_C)$$



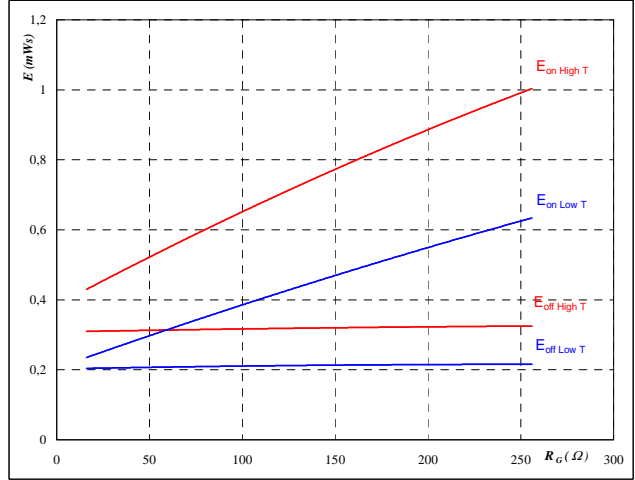
With an inductive load at

$T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 64$  Ω  
 $R_{goff} = 64$  Ω

**Figure 6** Output inverter IGBT

Typical switching energy losses  
as a function of gate resistor

$$E = f(R_G)$$



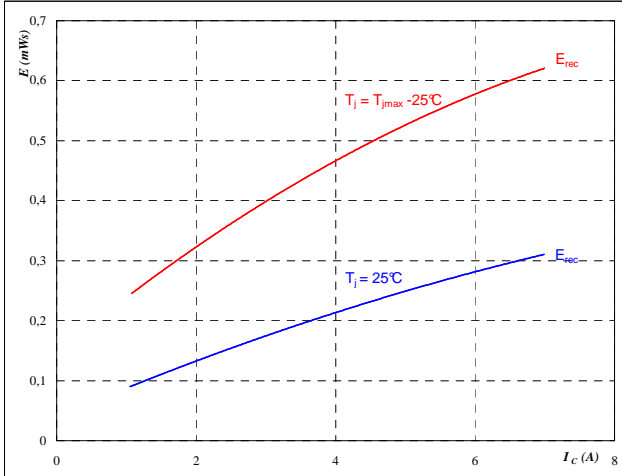
With an inductive load at

$T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 4$  A

**Figure 7** Output inverter FWD

Typical reverse recovery energy loss  
as a function of collector current

$$E_{rec} = f(I_C)$$



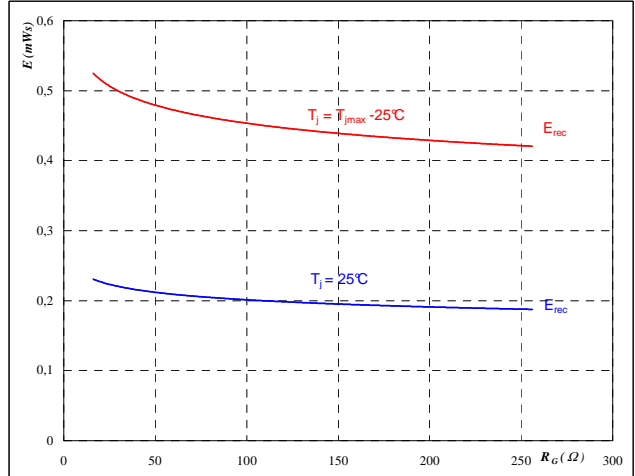
With an inductive load at

$T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 64$  Ω

**Figure 8** Output inverter FWD

Typical reverse recovery energy loss  
as a function of gate resistor

$$E_{rec} = f(R_G)$$



With an inductive load at

$T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 4$  A

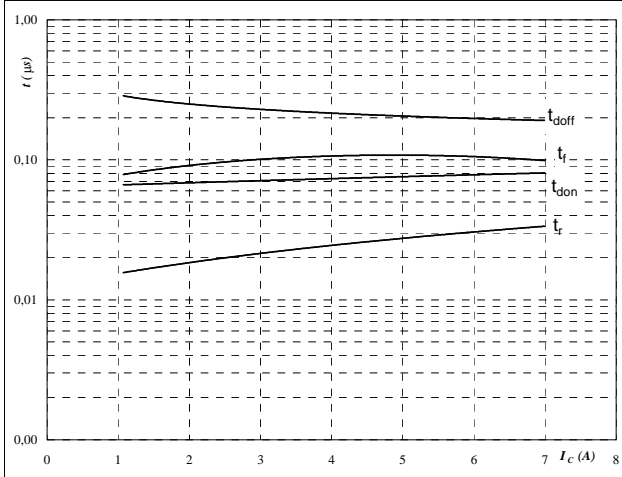


## Output Inverter

**Figure 9** Output inverter IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



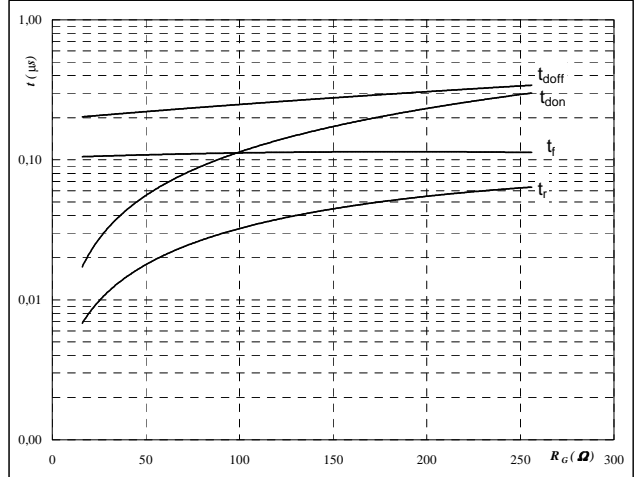
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	64	Ω
$R_{goff} =$	64	Ω

**Figure 10** Output inverter IGBT

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



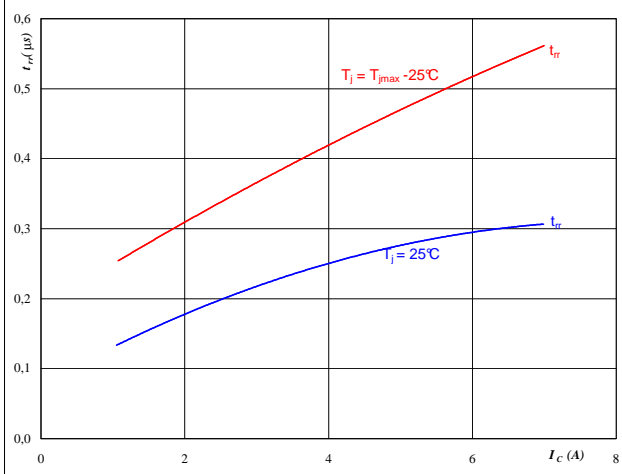
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	4	A

**Figure 11** Output inverter FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



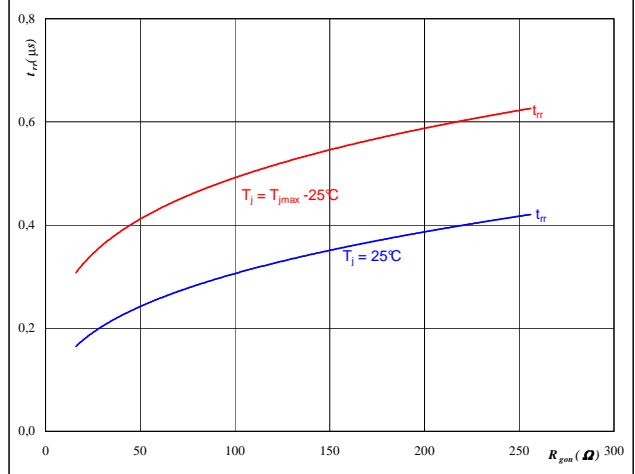
At

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	64	Ω

**Figure 12** Output inverter FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

$T_j =$	25/150	°C
$V_R =$	600	V
$I_F =$	4	A
$V_{GE} =$	±15	V

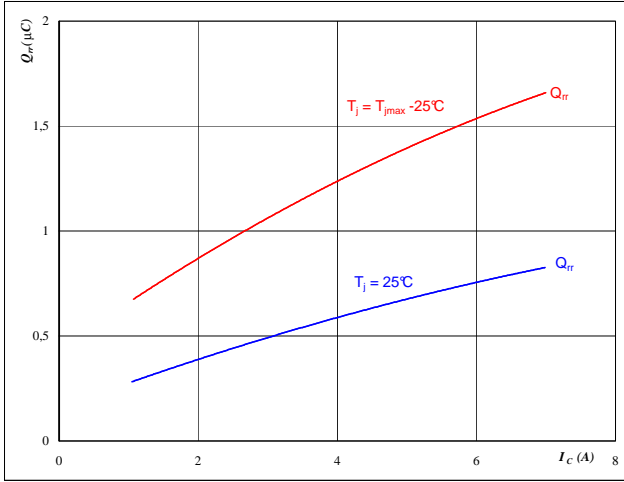


### Output Inverter

Figure 13 Output inverter FWD

Typical reverse recovery charge as a function of collector current

$Q_{rr} = f(I_c)$

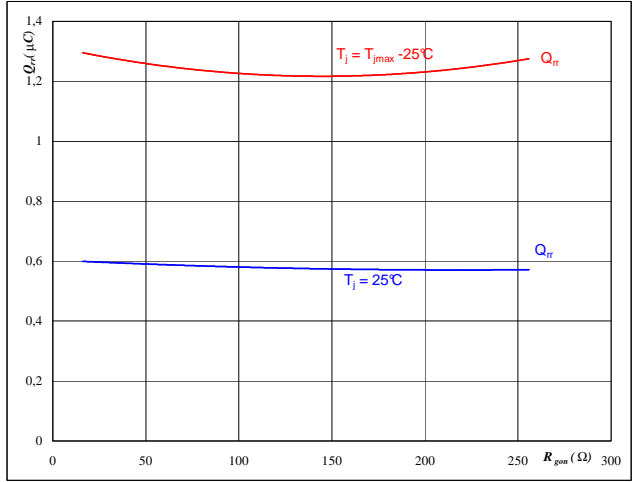


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 64$   $\Omega$

Figure 14 Output inverter FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$Q_{rr} = f(R_{gon})$

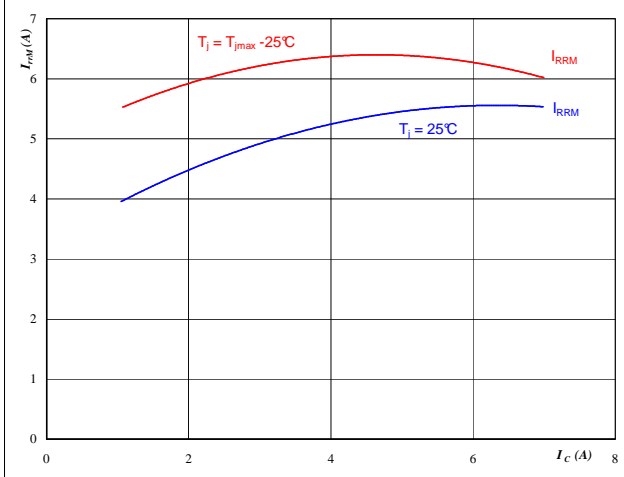


**At**  
 $T_j = 25/150$  °C  
 $V_R = 600$  V  
 $I_F = 4$  A  
 $V_{GE} = \pm 15$  V

Figure 15 Output inverter FWD

Typical reverse recovery current as a function of collector current

$I_{RRM} = f(I_c)$

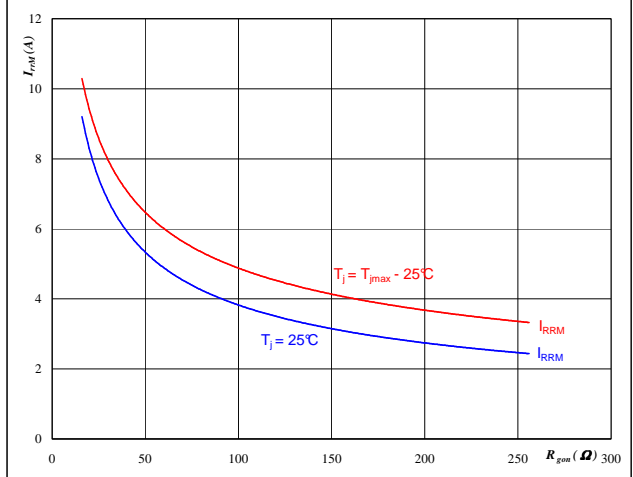


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 64$   $\Omega$

Figure 16 Output inverter FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$I_{RRM} = f(R_{gon})$



**At**  
 $T_j = 25/150$  °C  
 $V_R = 600$  V  
 $I_F = 4$  A  
 $V_{GE} = \pm 15$  V



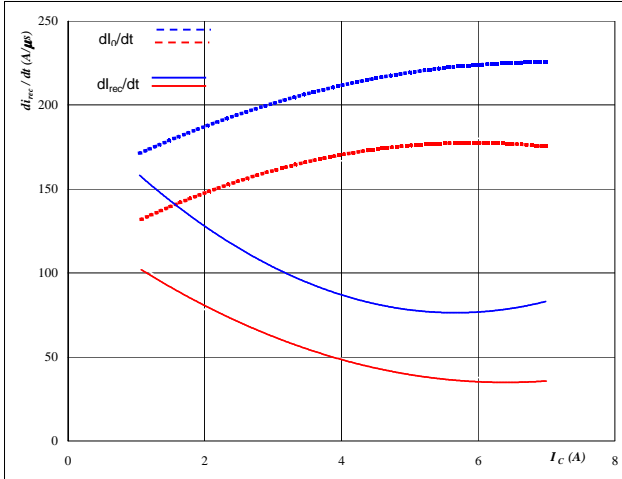


# Output Inverter

**Figure 17** Output inverter FWD

**Typical rate of fall of forward and reverse recovery current as a function of collector current**

$$dI_0/dt, dI_{rec}/dt = f(I_C)$$

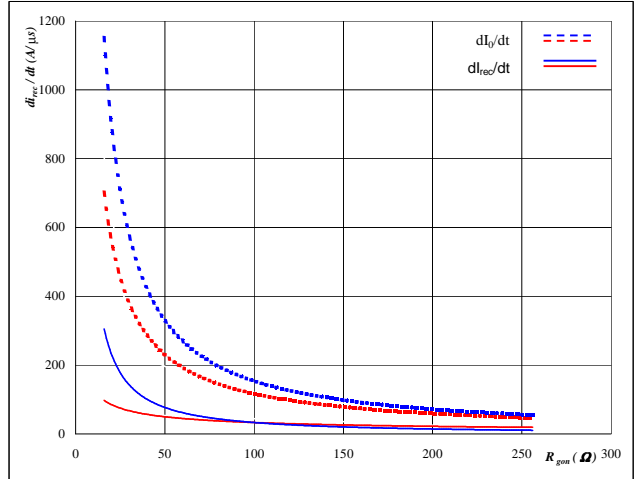


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 64$   $\Omega$

**Figure 18** Output inverter FWD

**Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor**

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

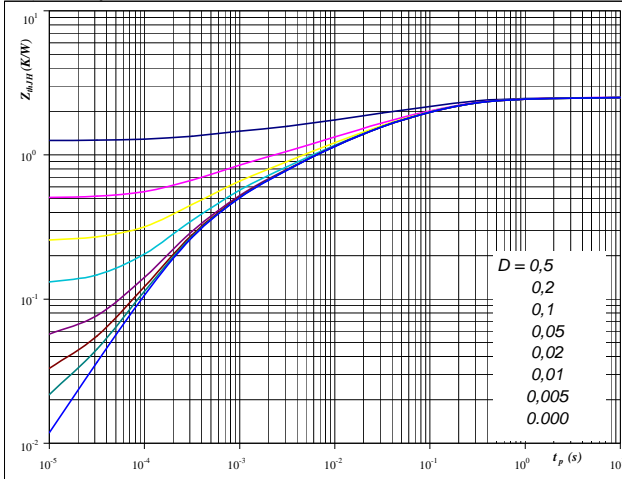


**At**  
 $T_j = 25/150$  °C  
 $V_R = 600$  V  
 $I_F = 4$  A  
 $V_{GE} = \pm 15$  V

**Figure 19** Output inverter IGBT

**IGBT transient thermal impedance as a function of pulse width**

$$Z_{thjH} = f(t_p)$$



**At**  
 $D = t_p / T$   
 $R_{thjH} = 2,51$  K/W     $R_{thjH} = 2,18$  K/W

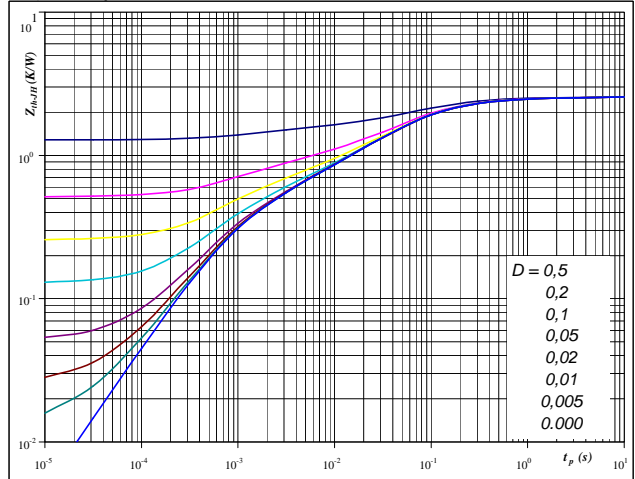
**IGBT thermal model values**

Thermal grease		Phase change material	
R (K/W)	Tau (s)	R (K/W)	Tau (s)
0,05	6,2E+00	0,04	6,2E+00
0,26	4,9E-01	0,23	4,9E-01
0,85	8,6E-02	0,74	8,6E-02
0,64	1,3E-02	0,56	1,3E-02
0,38	2,2E-03	0,33	2,2E-03
0,33	3,4E-04	0,28	3,4E-04

**Figure 20** Output inverter FWD

**FWD transient thermal impedance as a function of pulse width**

$$Z_{thjH} = f(t_p)$$



**At**  
 $D = t_p / T$   
 $R_{thjH} = 2,56$  K/W     $R_{thjH} = 2,23$  K/W

**FWD thermal model values**

Thermal grease		Phase change material	
R (K/W)	Tau (s)	R (K/W)	Tau (s)
0,12	2,8E+00	0,11	2,8E+00
0,62	2,1E-01	0,54	2,1E-01
1,10	4,8E-02	0,95	4,8E-02
0,37	7,2E-03	0,33	7,2E-03
0,35	8,8E-04	0,30	8,8E-04

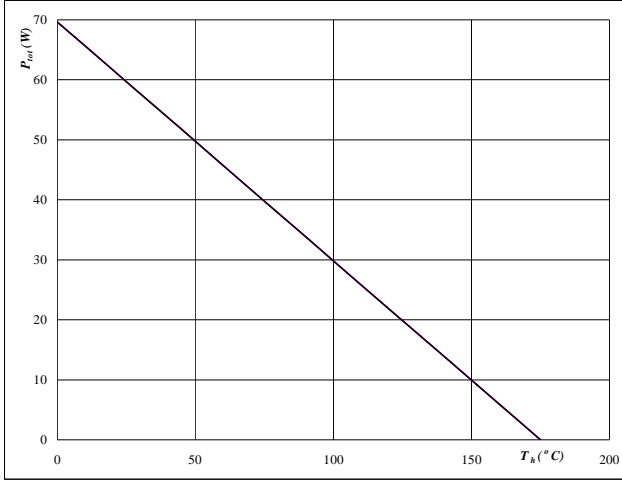


# Output Inverter

Figure 21 Output inverter IGBT

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

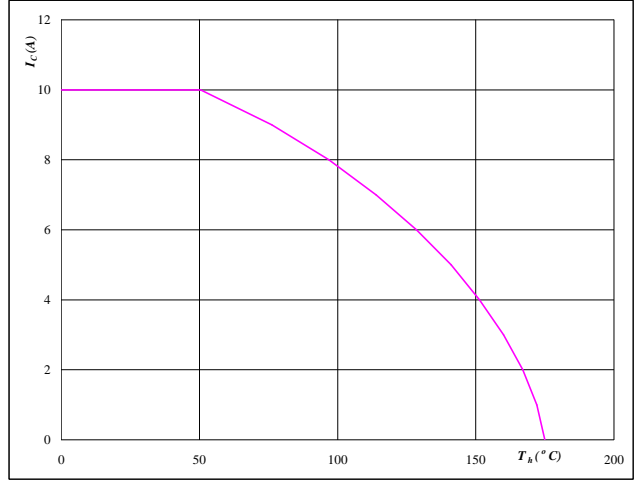


At  
T<sub>j</sub> = 175 °C

Figure 22 Output inverter IGBT

Collector current as a function of heatsink temperature

$I_c = f(T_h)$

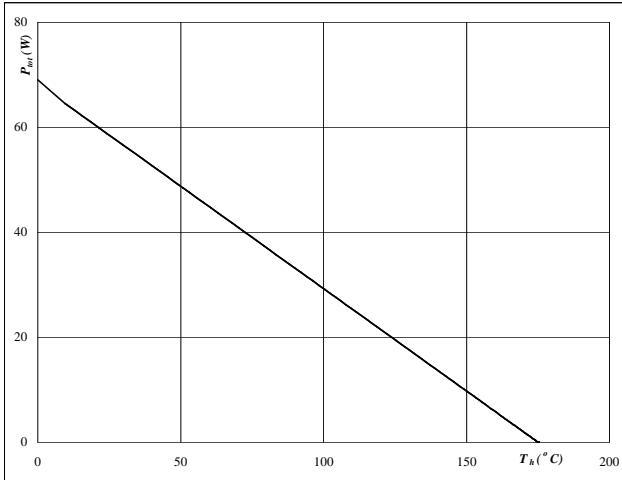


At  
T<sub>j</sub> = 175 °C  
V<sub>GE</sub> = 15 V

Figure 23 Output inverter FWD

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

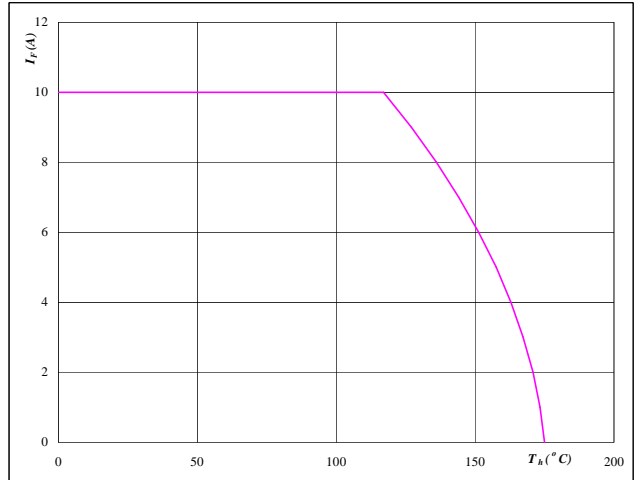


At  
T<sub>j</sub> = 175 °C

Figure 24 Output inverter FWD

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



At  
T<sub>j</sub> = 175 °C

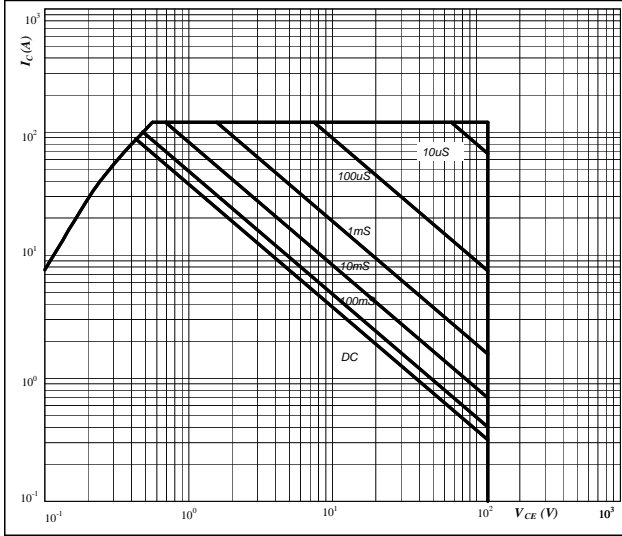


## Output Inverter

**Figure 25** Output inverter IGBT

Safe operating area as a function of collector-emitter voltage

$$I_C = f(V_{CE})$$

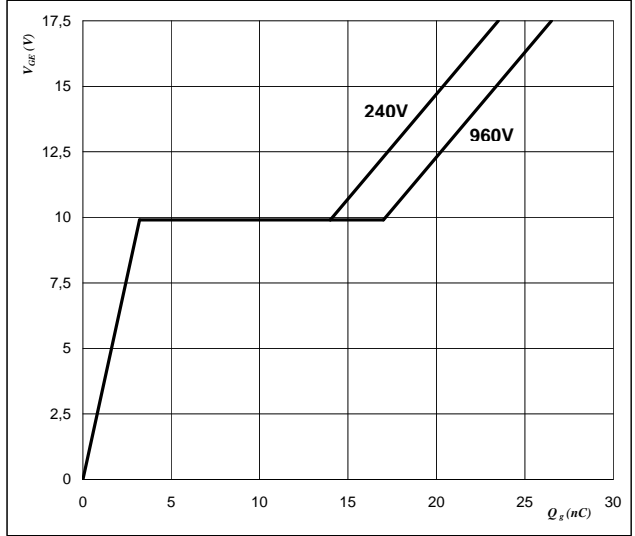


**At**  
 $D =$  single pulse  
 $T_h =$  80 °C  
 $V_{GE} =$  ±15 V  
 $T_j =$   $T_{jmax}$  °C

**Figure 26** Output inverter IGBT

Gate voltage vs Gate charge

$$V_{GE} = f(Q_{GE})$$

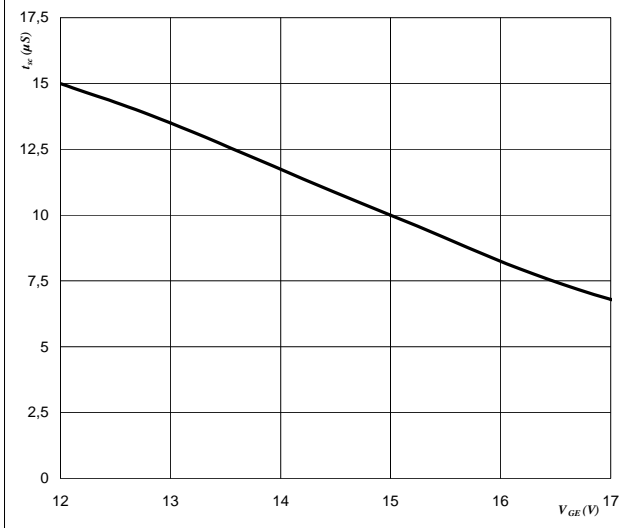


**At**  
 $I_C =$  4 A

**Figure 27** Output inverter IGBT

Short circuit withstand time as a function of gate-emitter voltage

$$t_{sc} = f(V_{GE})$$

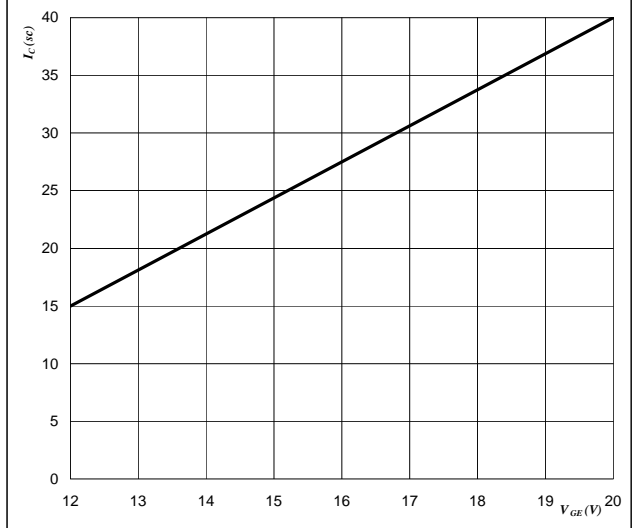


**At**  
 $V_{CE} =$  1200 V  
 $T_j \leq$  175 °C

**Figure 28** Output inverter IGBT

Typical short circuit collector current as a function of gate-emitter voltage

$$I_C = f(Q_{GE})$$



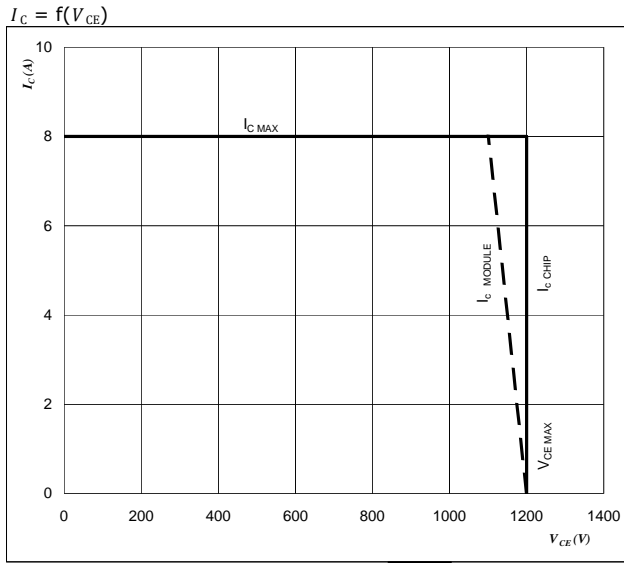
**At**  
 $V_{CE} \leq$  1200 V  
 $T_j =$  175 °C



Vincotech

Figure 29 IGBT

Reverse bias safe operating area



At

$T_j = T_{jmax} - 25 \text{ } ^\circ\text{C}$

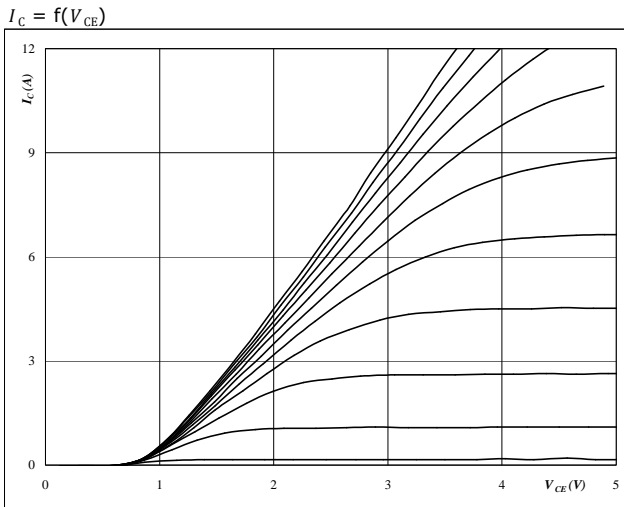
Ucminus=Ucplus

Switching mode : 3 level switching



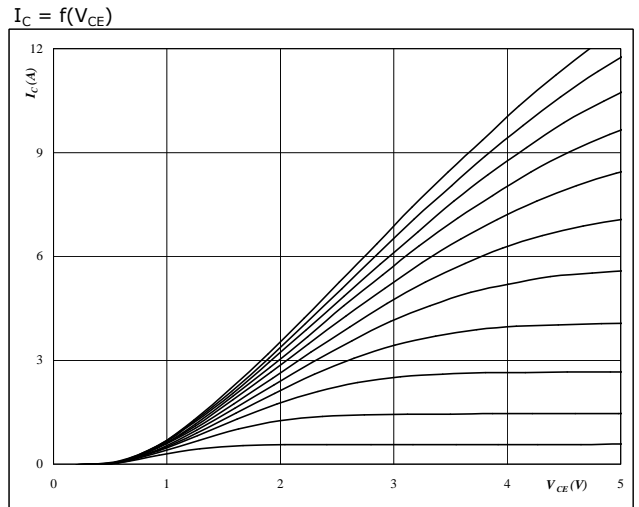
# Brake

**Figure 1** Brake IGBT  
**Typical output characteristics**



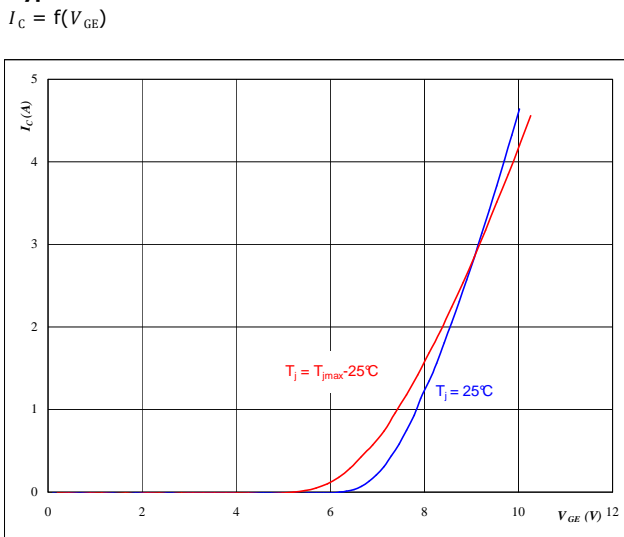
**At**  
 $t_p = 250 \mu s$   
 $T_j = 25 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 2** Brake IGBT  
**Typical output characteristics**



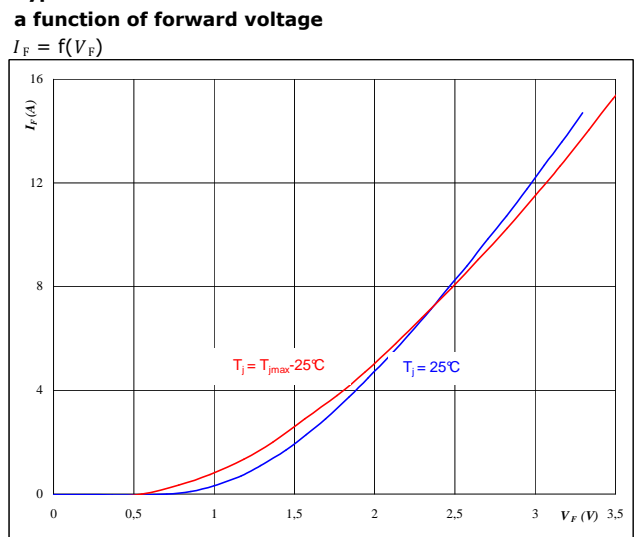
**At**  
 $t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 3** Brake IGBT  
**Typical transfer characteristics**



**At**  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

**Figure 4** Brake FWD  
**Typical diode forward current as a function of forward voltage**



**At**  
 $t_p = 250 \mu s$

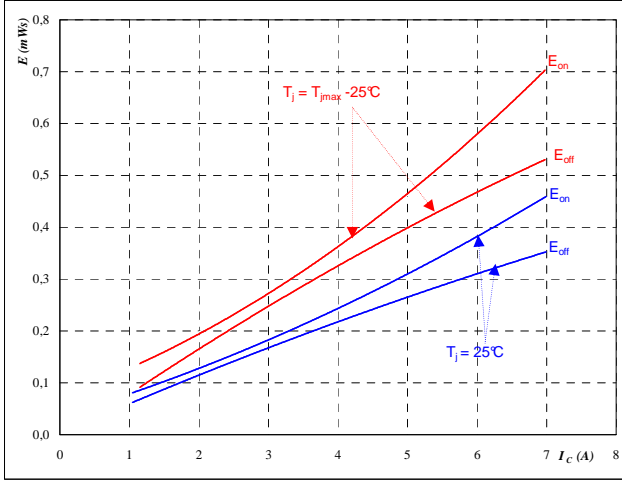


# Brake

**Figure 5** Brake IGBT

**Typical switching energy losses as a function of collector current**

$E = f(I_C)$



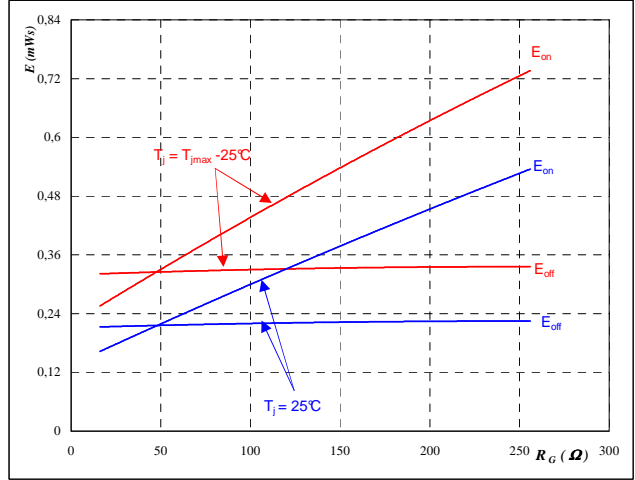
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 64$  Ω
- $R_{goff} = 64$  Ω

**Figure 6** Brake IGBT

**Typical switching energy losses as a function of gate resistor**

$E = f(R_G)$



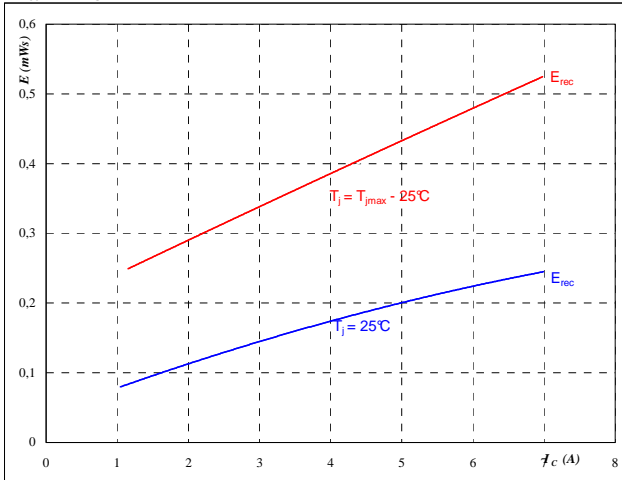
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $I_C = 4$  A

**Figure 7** Brake FWD

**Typical reverse recovery energy loss as a function of collector current**

$E_{rec} = f(I_C)$



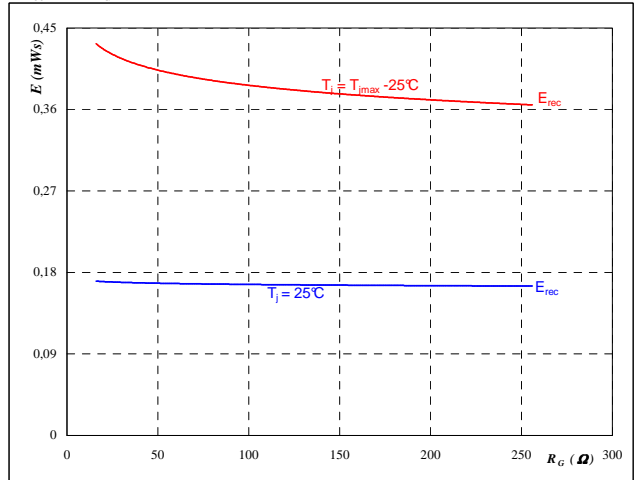
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 64$  Ω

**Figure 8** Brake FWD

**Typical reverse recovery energy loss as a function of gate resistor**

$E_{rec} = f(R_G)$



With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $I_C = 4$  A

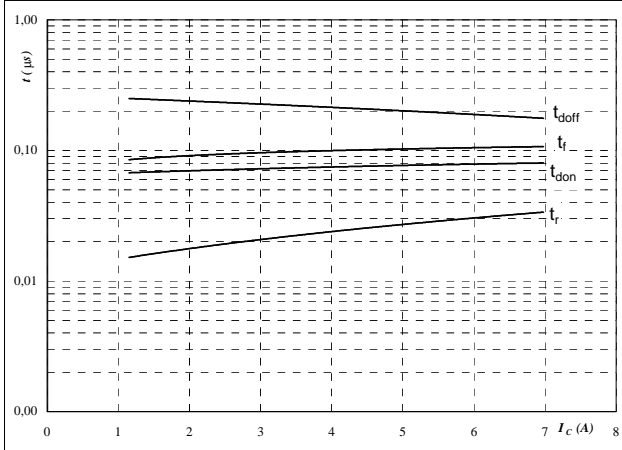


# Brake

**Figure 9** Brake IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$

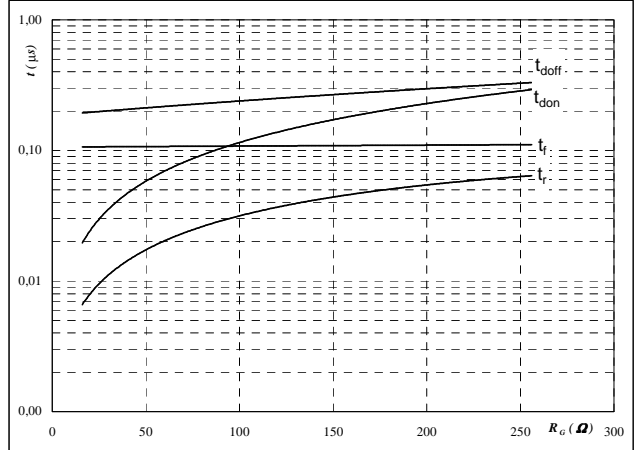


With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 64 \text{ } \Omega$   
 $R_{goff} = 64 \text{ } \Omega$

**Figure 10** Brake IGBT

Typical switching times as a function of gate resistor

$$t = f(R_G)$$

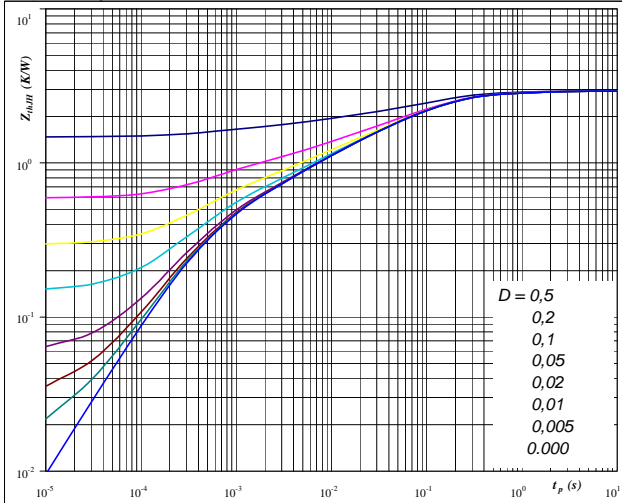


With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 4 \text{ A}$

**Figure 11** Brake IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{thjH} = f(t_p)$$

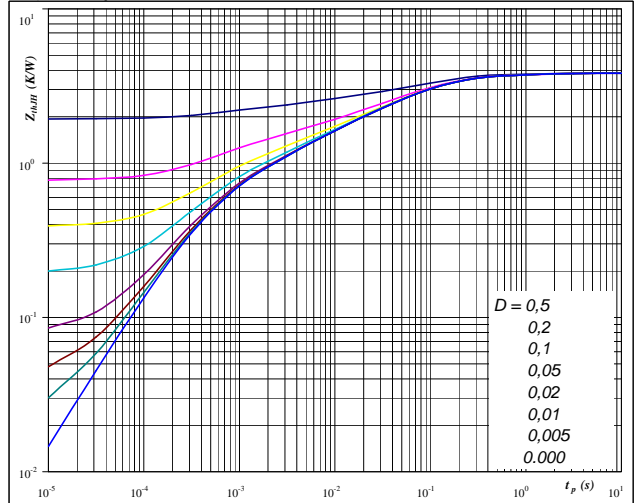


**At**  $D = t_p / T$   
 Thermal grease  $R_{thjH} = 2,95 \text{ K/W}$   
 Phase change material  $R_{thjH} = 2,56 \text{ K/W}$

**Figure 12** Brake FWD

FWD transient thermal impedance as a function of pulse width

$$Z_{thjH} = f(t_p)$$



**At**  $D = t_p / T$   
 Thermal grease  $R_{thjH} = 3,86 \text{ K/W}$   
 Phase change material  $R_{thjH} = 3,38 \text{ K/W}$

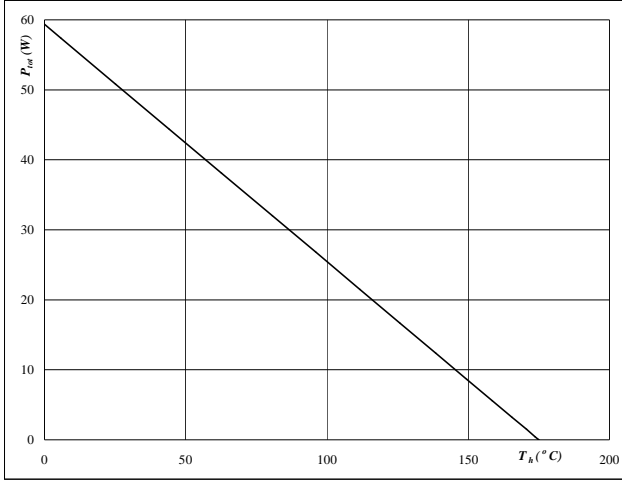


# Brake

Figure 13 Brake IGBT

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

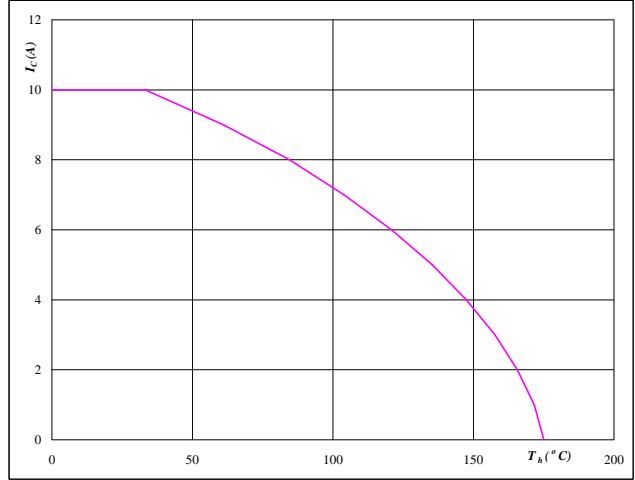


At  
 $T_j = 175$  °C

Figure 14 Brake IGBT

Collector current as a function of heatsink temperature

$I_C = f(T_h)$

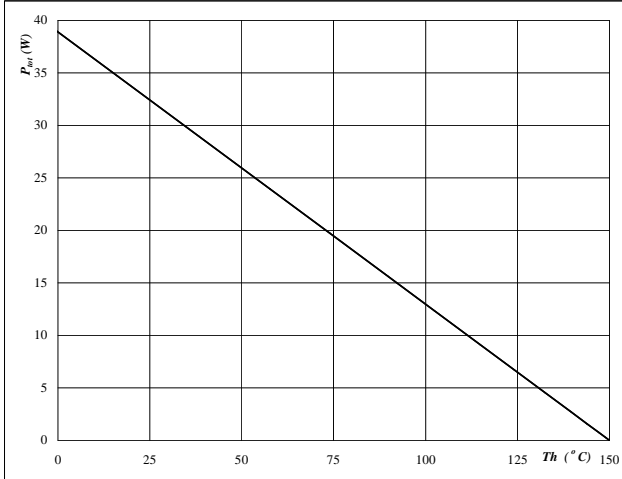


At  
 $T_j = 175$  °C  
 $V_{GE} = 15$  V

Figure 15 Brake FWD

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

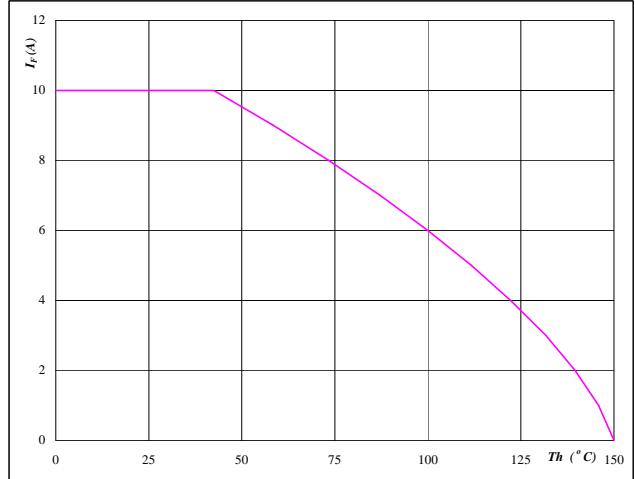


At  
 $T_j = 150$  °C

Figure 16 Brake FWD

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



At  
 $T_j = 150$  °C



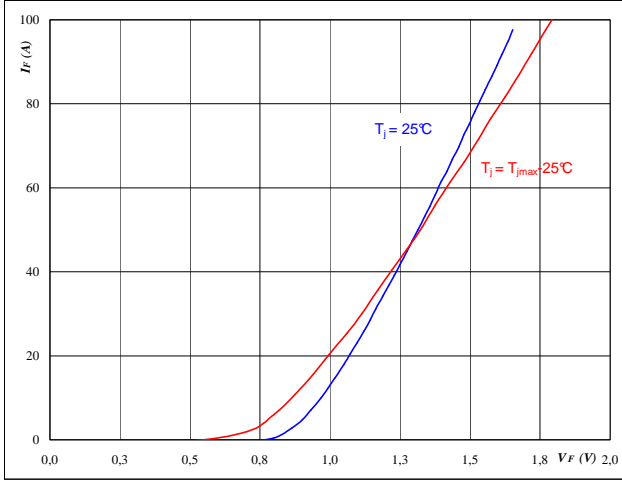


# Input Rectifier Bridge

**Figure 1** Rectifier diode

**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$

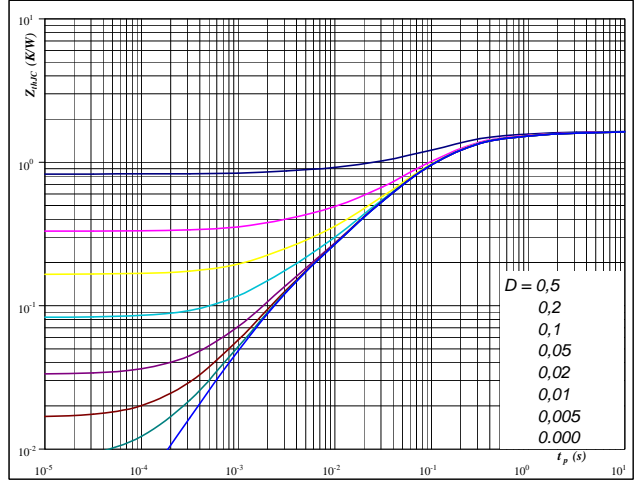


**At**  
 $t_p = 250 \mu s$

**Figure 2** Rectifier diode

**Diode transient thermal impedance as a function of pulse width**

$$Z_{thjH} = f(t_p)$$

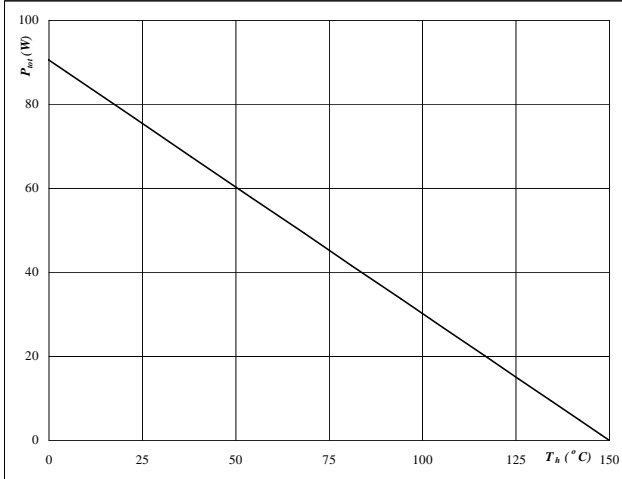


**At**  
 $D = t_p / T$   
 Thermal grease  $R_{thjH} = 1,80 \text{ K/W}$   
 Phase change material  $R_{thjH} = 1,54 \text{ K/W}$

**Figure 3** Rectifier diode

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_h)$$

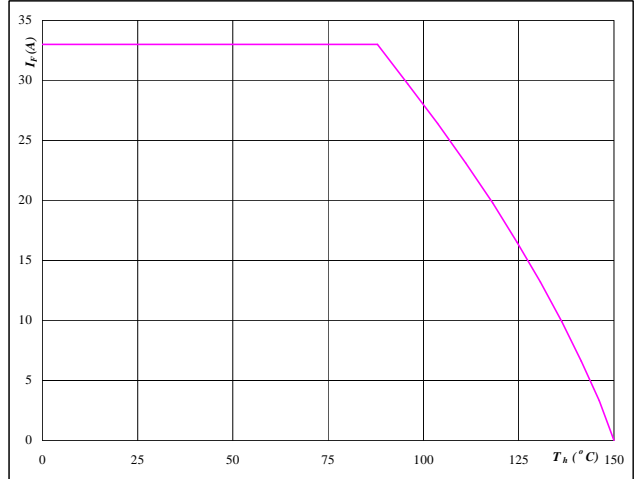


**At**  
 $T_j = 150 \text{ }^\circ\text{C}$

**Figure 4** Rectifier diode

**Forward current as a function of heatsink temperature**

$$I_F = f(T_h)$$



**At**  
 $T_j = 150 \text{ }^\circ\text{C}$



# Thermistor

Figure 1 Thermistor

Typical NTC characteristic  
as a function of temperature

$$R_T = f(T)$$

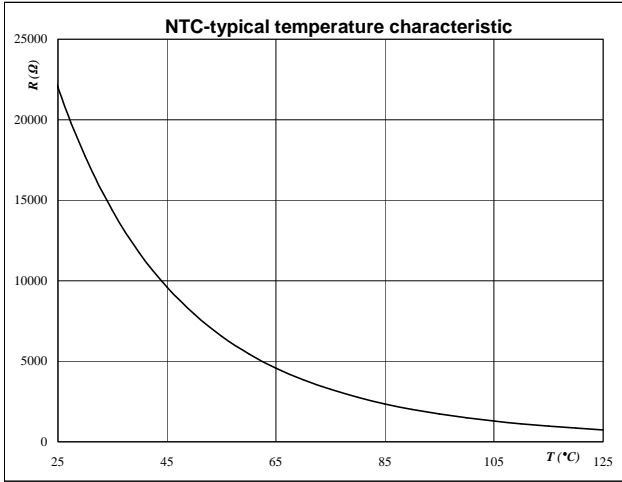


Figure 2 Thermistor

Typical NTC resistance values

$$R(T) = R_{25} \cdot e^{\left( B_{25/100} \left( \frac{1}{T} - \frac{1}{T_{25}} \right) \right)} \quad [\Omega]$$

T [°C]	R <sub>nom</sub> [Ω]	R <sub>min</sub> [Ω]	R <sub>max</sub> [Ω]	ΔR/R [±%]
-55	2089434,5	1506495,4	2672373,6	27,9
0	71804,2	59724,4	83884	16,8
10	43780,4	37094,4	50466,5	15,3
20	27484,6	23684,6	31284,7	13,8
25	22000	19109,3	24890,7	13,1
30	17723,3	15512,2	19934,4	12,5
60	5467,9	4980,6	5955,1	8,9
70	3848,6	3546	4151,1	7,9
80	2757,7	2568,2	2947,1	6,9
90	2008,9	1889,7	2128,2	5,9
100	<b>1486,1</b>	<b>1411,8</b>	<b>1560,4</b>	<b>5</b>
150	400,2	364,8	435,7	8,8



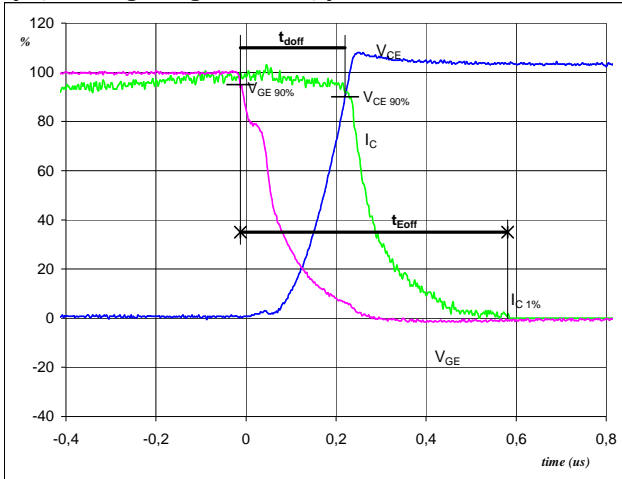
## Switching Definitions Output Inverter

### General conditions

$T_j$	=	150 °C
$R_{gon}$	=	64 $\Omega$
$R_{goff}$	=	64 $\Omega$

**Figure 1** Output inverter IGBT

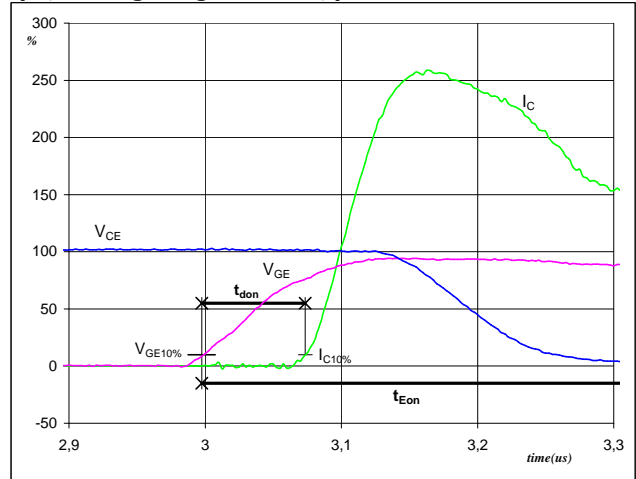
**Turn-off Switching Waveforms & definition of  $t_{doff}$   $t_{Eoff}$**   
( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE} (0\%) =$	-15	V
$V_{GE} (100\%) =$	15	V
$V_C (100\%) =$	600	V
$I_C (100\%) =$	4	A
$t_{doff} =$	0,23	$\mu$ S
$t_{Eoff} =$	0,59	$\mu$ S

**Figure 2** Output inverter IGBT

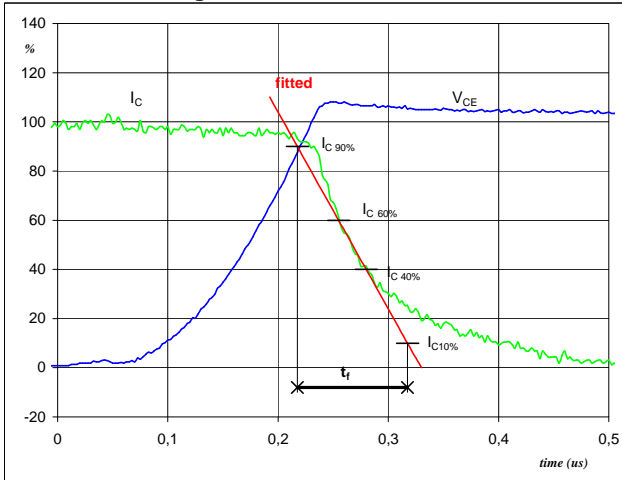
**Turn-on Switching Waveforms & definition of  $t_{don}$   $t_{Eon}$**   
( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE} (0\%) =$	-15	V
$V_{GE} (100\%) =$	15	V
$V_C (100\%) =$	600	V
$I_C (100\%) =$	4	A
$t_{don} =$	0,08	$\mu$ S
$t_{Eon} =$	0,32	$\mu$ S

**Figure 3** Output inverter IGBT

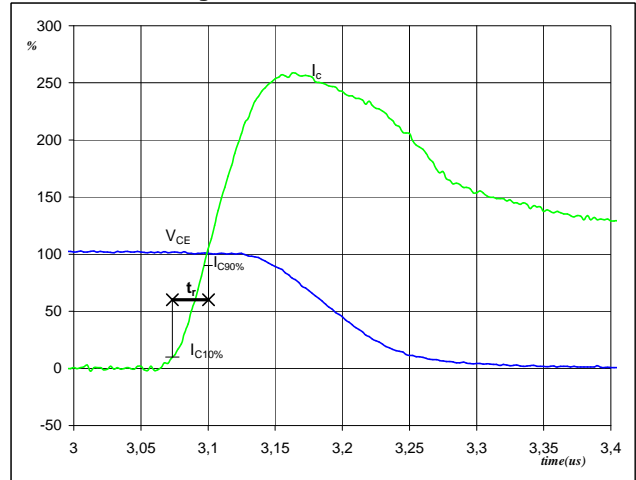
**Turn-off Switching Waveforms & definition of  $t_f$**



$V_C (100\%) =$	600	V
$I_C (100\%) =$	4	A
$t_f =$	0,11	$\mu$ S

**Figure 4** Output inverter IGBT

**Turn-on Switching Waveforms & definition of  $t_r$**

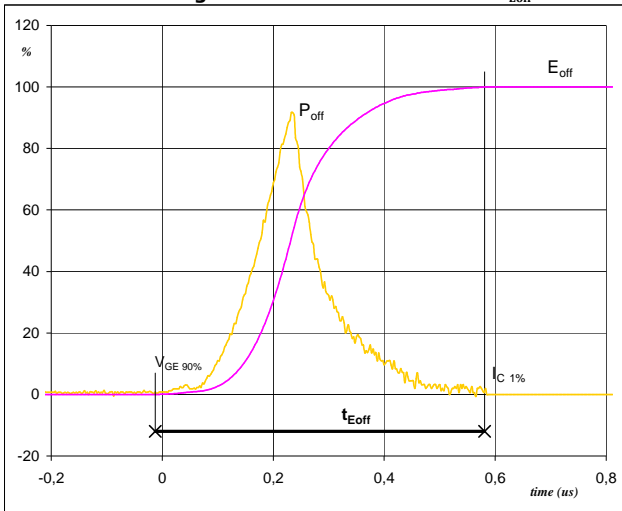


$V_C (100\%) =$	600	V
$I_C (100\%) =$	4	A
$t_r =$	0,02	$\mu$ S



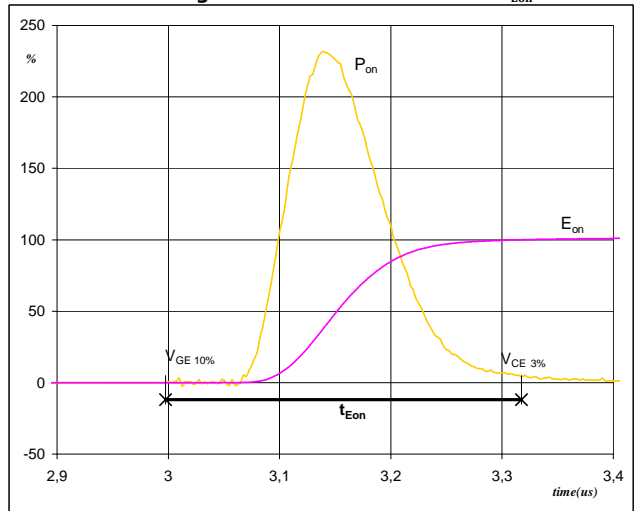
## Switching Definitions Output Inverter

**Figure 5** Output inverter IGBT  
**Turn-off Switching Waveforms & definition of  $t_{Eoff}$**



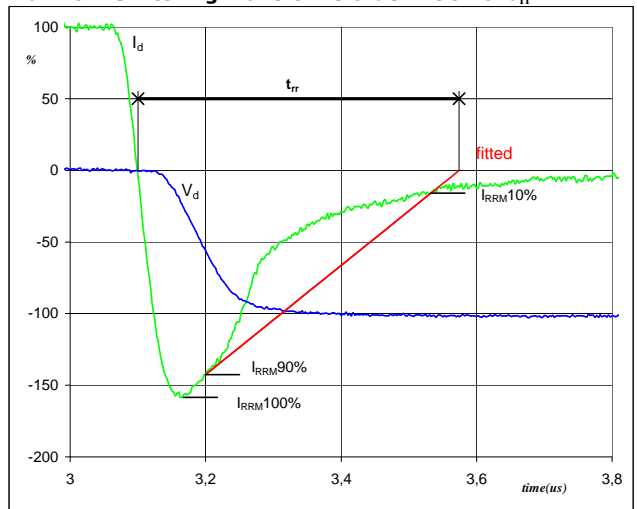
$P_{off} (100\%) = 2,41 \text{ kW}$   
 $E_{off} (100\%) = 0,32 \text{ mJ}$   
 $t_{Eoff} = 0,59 \text{ } \mu\text{s}$

**Figure 6** Output inverter IGBT  
**Turn-on Switching Waveforms & definition of  $t_{Eon}$**



$P_{on} (100\%) = 2,41 \text{ kW}$   
 $E_{on} (100\%) = 0,56 \text{ mJ}$   
 $t_{Eon} = 0,32 \text{ } \mu\text{s}$

**Figure 7** Output inverter FWD  
**Turn-off Switching Waveforms & definition of  $t_{rr}$**



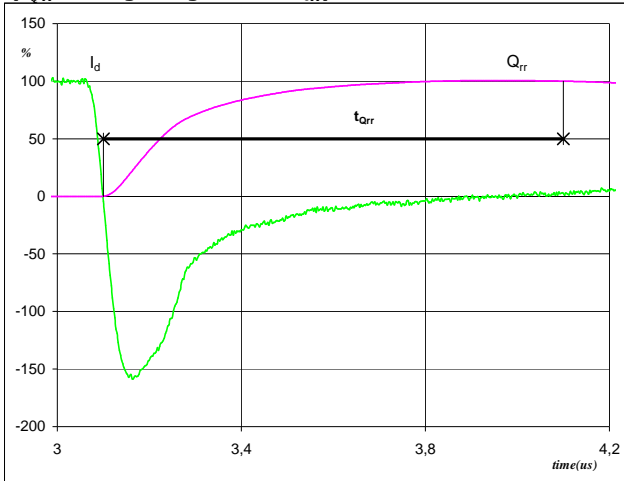
$V_d (100\%) = 600 \text{ V}$   
 $I_d (100\%) = 4 \text{ A}$   
 $I_{RRM} (100\%) = -6 \text{ A}$   
 $t_{rr} = 0,43 \text{ } \mu\text{s}$



### Switching Definitions Output Inverter

Figure 8 Output inverter FWD

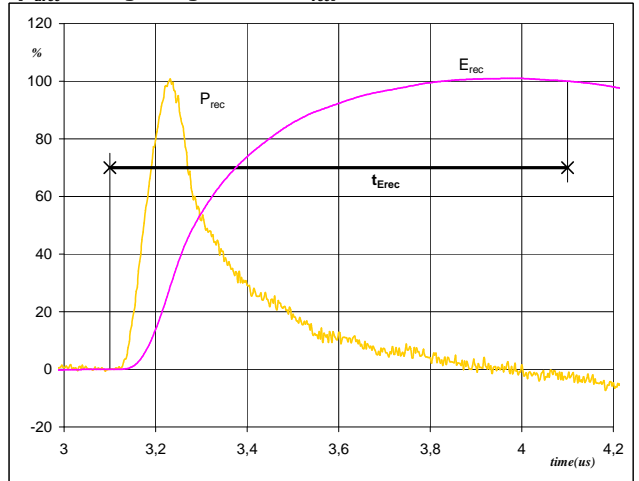
Turn-on Switching Waveforms & definition of  $t_{Qrr}$   
( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )



$I_d$ (100%) =	4	A
$Q_{rr}$ (100%) =	1,24	$\mu C$
$t_{Qrr}$ =	1,00	$\mu s$

Figure 9 Output inverter FWD

Turn-on Switching Waveforms & definition of  $t_{Erec}$   
( $t_{Erec}$  = integrating time for  $E_{rec}$ )

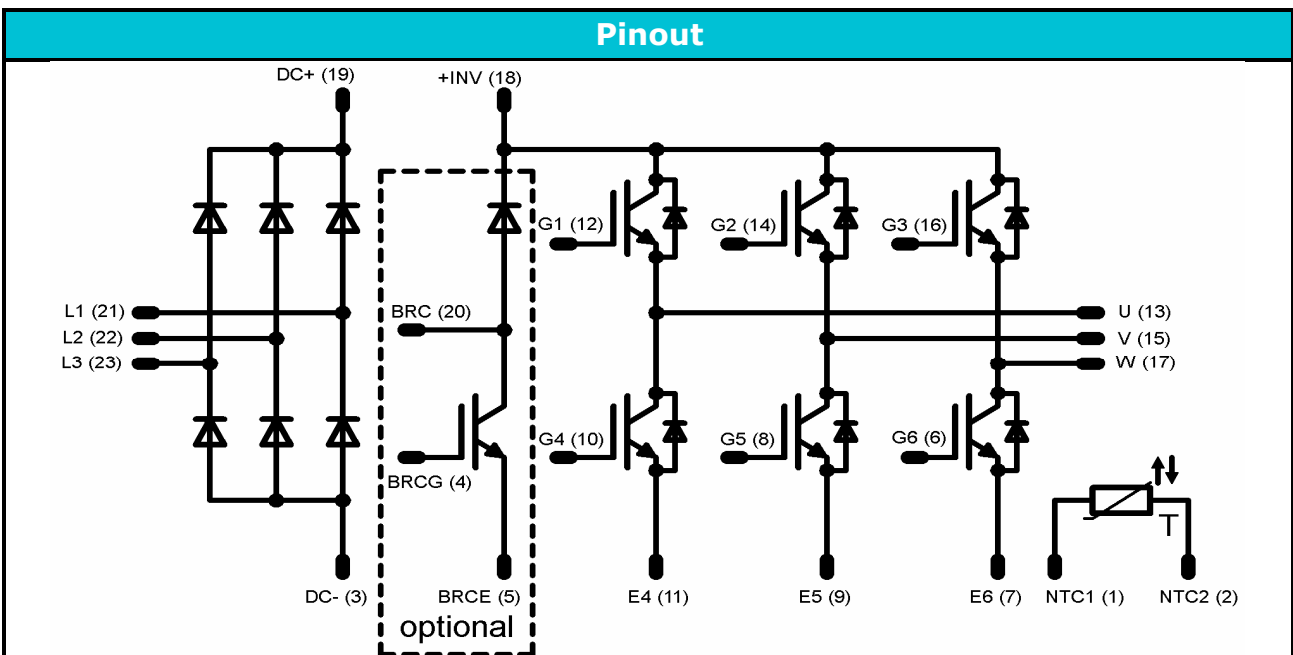
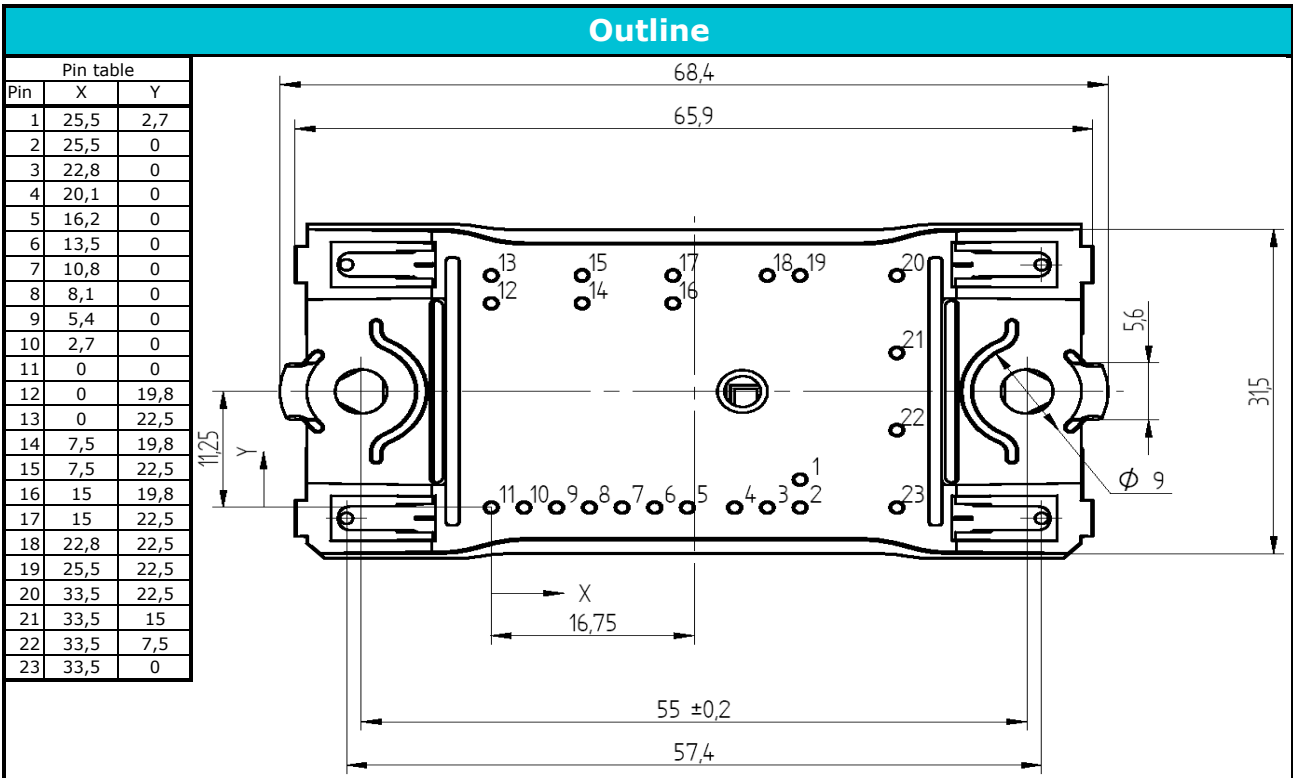


$P_{rec}$ (100%) =	2,41	kW
$E_{rec}$ (100%) =	0,47	mJ
$t_{Erec}$ =	1,00	$\mu s$



### Ordering Code and Marking - Outline - Pinout

Ordering Code & Marking			
Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste 12mm housing	V23990-P848-A58-(opt.)-PM	P848-A58	P848-A58
without thermal paste 17mm housing	V23990-P848-A59-(opt.)-PM	P848-A59	P848-A59
without thermal paste 12mm housing	V23990-P848-C58-(opt.)-PM	P848-C58	P848-C58
without thermal paste 17mm housing	V23990-P848-C59-(opt.)-PM	P848-C59	P848-C59





**DISCLAIMER**

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As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.